



# Product Change Notification

**Change Notification #:** 114589 - 00  
**Change Title:** Intel® Server System R2224GZ4GC4,  
PCN 114589-00, Product Design,  
Air duct improvement  
**Date of Publication:** May 10, 2016

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

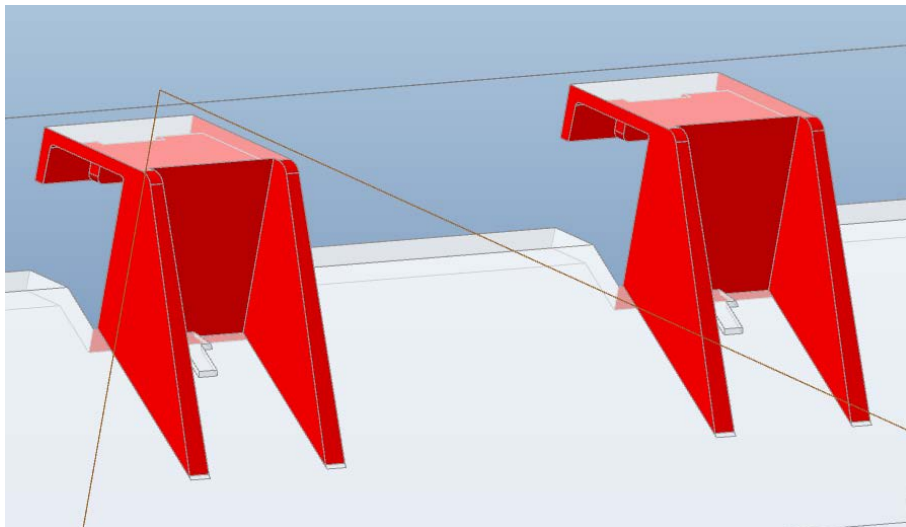
<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	May 24, 2016
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

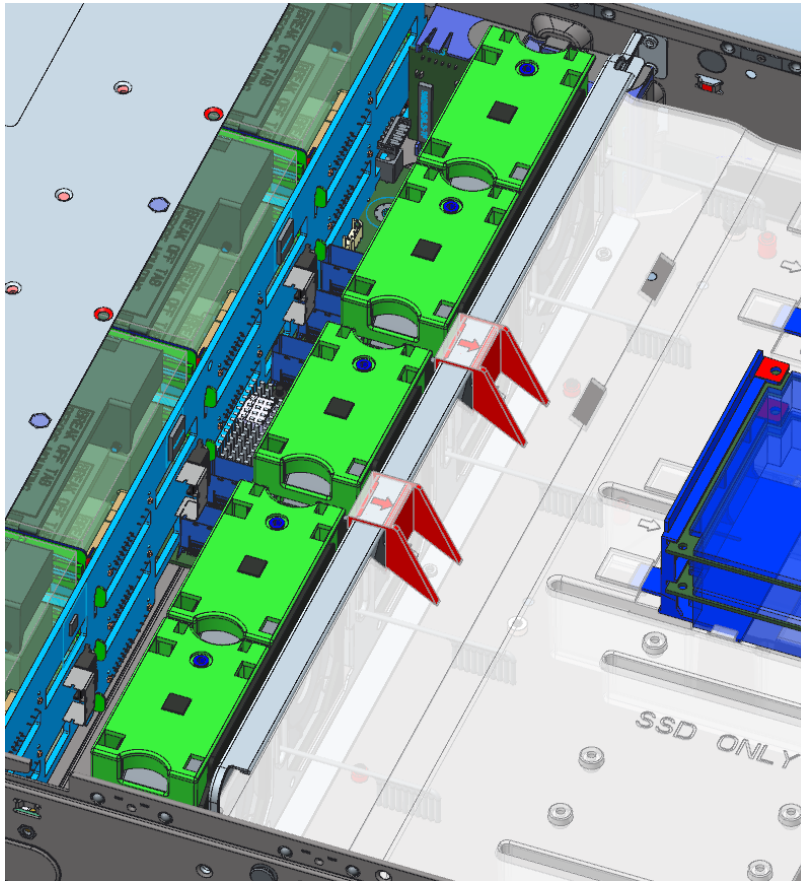
## Description of Change to the Customer:

Intel is implementing the following change on the Intel® Server System R2224GZ4GC4:

1. Change air duct lock feature: Change air duct lock hook so the air duct will hook over the FAN bulkhead. This will improve the fixing of air duct during transportation.



New air duct lock hook



New air duct lock hook

**Customer Impact of Change and Recommended Action:**

Intel does not expect any impact to customers from this change, but encourages customers to understand the change and determine the impact on their applications.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Post Change TA
R2224GZ4GC4	921971	G63774-011	G63774-012

**PCN Revision History:**

**Date of Revision:**

May 10, 2016

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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